





QUAD SURFACE MOUNT SWITCHING DIODE ARRAY

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- One BAV70 Circuit and One BAW56 Circuit In One Package
- Easily Connected As Full Wave Bridge
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Notes 4 and 5)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.006 grams (approximate)

SOT-363





Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|--|--|------------|------|
| Non-Repetitive Peak Reverse Voltage | V_{RM} | 100 | V |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 75 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 53 | V |
| Forward Continuous Current (Notes 1 and 2) | I _{FM} | 300 | mA |
| Average Rectified Output Current (Notes 1 and 2) | lo | 150 | mA |
| Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s | I _{FSM} | 2.0 1.0 | Α |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Notes 1 and 2) | P _D | 200 | mW |
| Power Dissipation T _S = 60°C (Note 2) | P _D | 300 | mW |
| Thermal Resistance Junction to Ambient Air (Notes 1 and 2) | $R_{	heta JA}$ | 625 | °C/W |
| Thermal Resistance Junction to Soldering Point (Note 2) | $R_{\theta JS}$ | 275 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

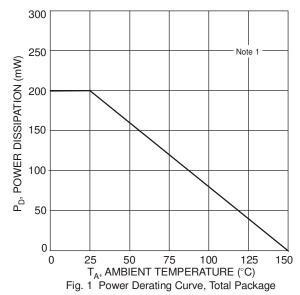
Electrical Characteristics @T_A = 25°C unless otherwise specified

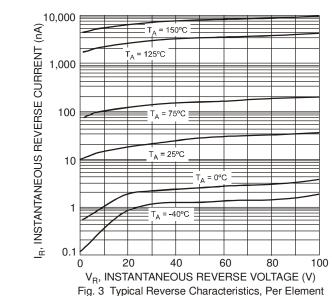
| Characteristic | Symbol | Min | Max | Unit | Test Condition |
|------------------------------------|-----------------|-----|-------------------------------|----------------------|--|
| Reverse Breakdown Voltage (Note 6) | $V_{(BR)R}$ | 75 | _ | V | $I_R = 2.5 \mu A$ |
| Forward Voltage | V _F | | 0.715 0.855 1.0 1.25 | V | I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA |
| Reverse Current (Note 6) | I _R | | 2.5 50 30 25 | μΑ μΑ μΑ nA | $V_R = 75V$ $V_R = 75V$, $T_J = 150$ °C $V_R = 25V$, $T_J = 150$ °C $V_R = 20V$ |
| Total Capacitance | Ст | _ | 2.0 | pF | $V_R = 0$, $f = 1.0MHz$ |
| Reverse Recovery Time | t _{rr} | _ | 4.0 | ns | $I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$ |

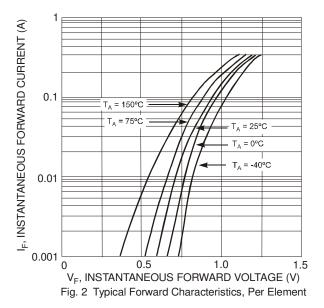
Notes:

- Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- One or more diodes loaded.
- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.
- 6. Short duration pulse test used to minimize self-heating effect.









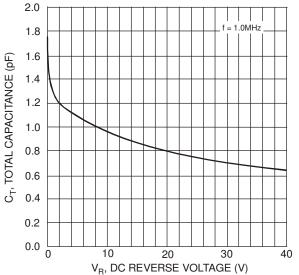


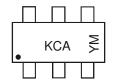
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Ordering Information (Notes 5 & 7)

| Part Number | Case | Packaging |
|--------------|---------|------------------|
| BAV756DW-7-F | SOT-363 | 3000/Tape & Reel |

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



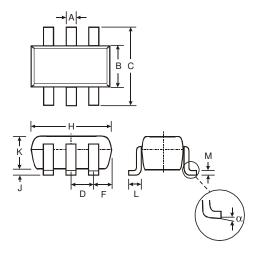
KCA = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

| Year | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2111 | 2012 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | М | N | Р | R | S | Т | U | ٧ | W | Х | Υ | Z |
| | | | | | | | | | | | | |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |

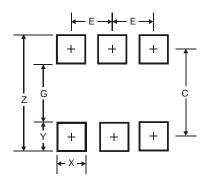


Package Outline Dimensions



| | SOT-363 | | | | | |
|--------|----------------------|------|--|--|--|--|
| Dim | Min | Max | | | | |
| Α | 0.10 | 0.30 | | | | |
| В | 1.15 | 1.35 | | | | |
| С | 2.00 | 2.20 | | | | |
| D | 0.65 Nominal | | | | | |
| F | 0.30 | 0.40 | | | | |
| Н | 1.80 | 2.20 | | | | |
| J | | 0.10 | | | | |
| K | 0.90 | 1.00 | | | | |
| L | 0.25 | 0.40 | | | | |
| M | 0.10 | 0.25 | | | | |
| α | 0° | 8° | | | | |
| All Di | All Dimensions in mm | | | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.5 |
| G | 1.3 |
| Х | 0.42 |
| Υ | 0.6 |
| С | 1.9 |
| E | 0.65 |

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